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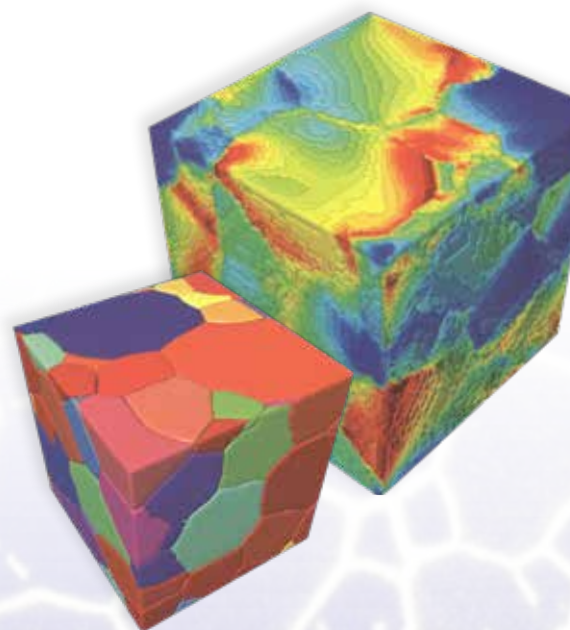
The 6th International Congress on

3DMS

3D Materials Science 2022

June 26–29, 2022

**Hyatt Regency Washington on Capitol Hill,
Washington, D.C., USA**



The congress program includes, but is not limited to, the following technical topics:

- New 3D characterization methods
- Multimodal 3D characterization
- Automated and autonomous 3D materials research
- 3D data processing and reconstruction algorithms
- Artificial intelligence methods for 3D data analysis
- Methods for 3D materials simulation and modelling
- Process-microstructure-property relationships in 3D
- Materials dynamics in 3D
- Other

Submissions will be considered for a topical collection of the TMS journal *Integrating Materials and Manufacturing Innovation* dedicated to the meeting. For more details and to submit your abstract, visit: www.tms.org/3DMS2022

CONGRESS ORGANIZERS

- **Dorte Juul Jensen**, Technical University of Denmark, Denmark
- **Marie Charpagne**, University of Illinois, USA
- **Keith Knipling**, Naval Research Laboratory, USA
- **Klaus-Dieter Liss**, Guangdong Technion - Israel Institute of Technology, China
- **Matthew P. Miller**, Cornell University, USA
- **David J. Rowenhorst**, U.S. Naval Research Laboratory, USA

“For me, the 3DMS congress series is outstanding and ‘a must’ to attend, as it is the cornerstone in building a new community within materials science.”

**- Dorte Juul Jensen,
3DMS 2021 Chair**

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